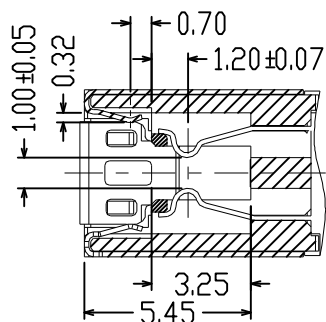
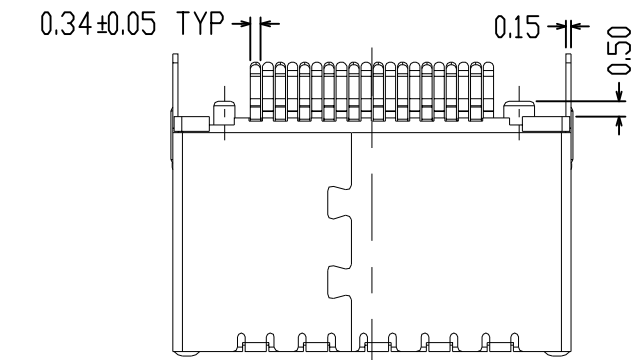
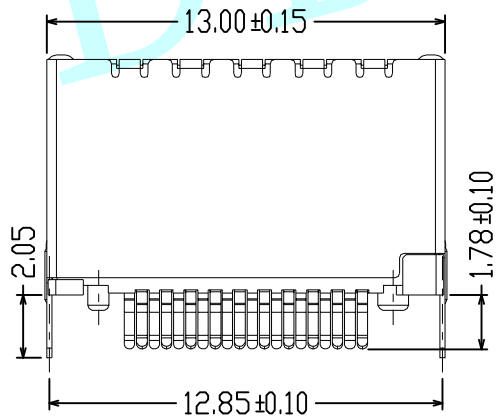
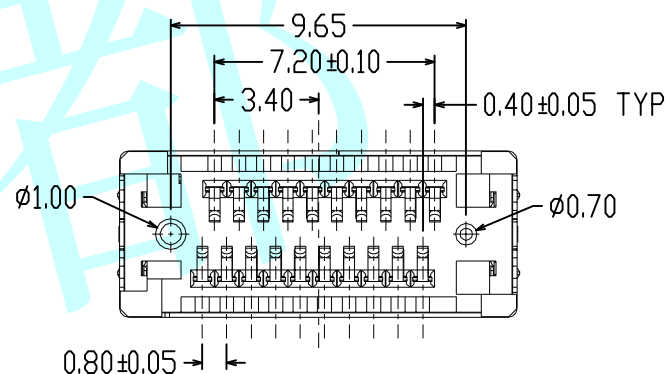
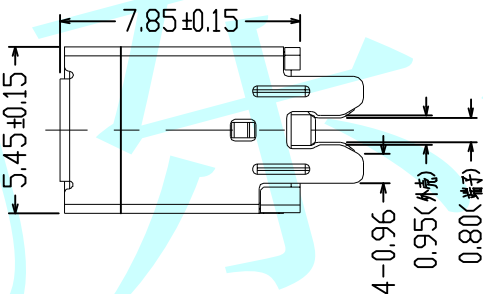
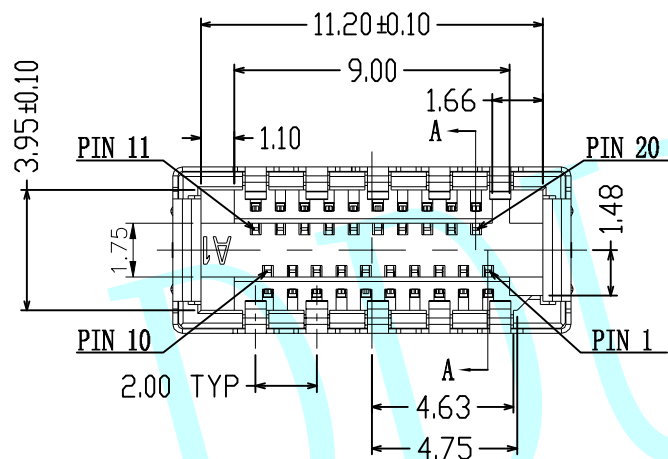


ROHS



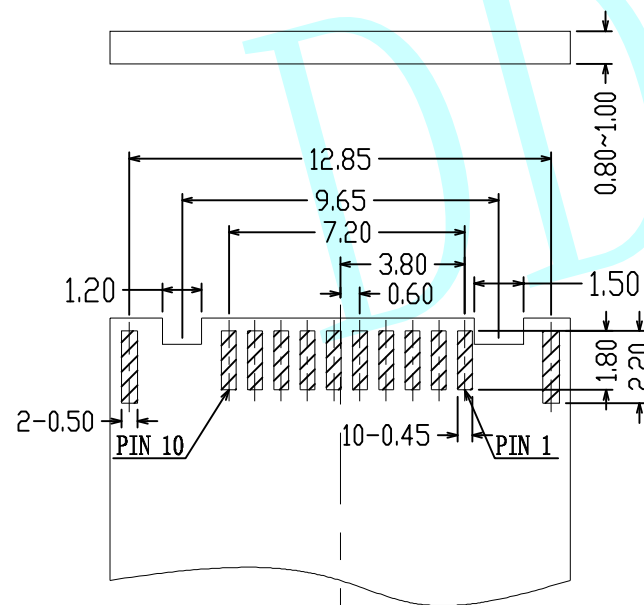
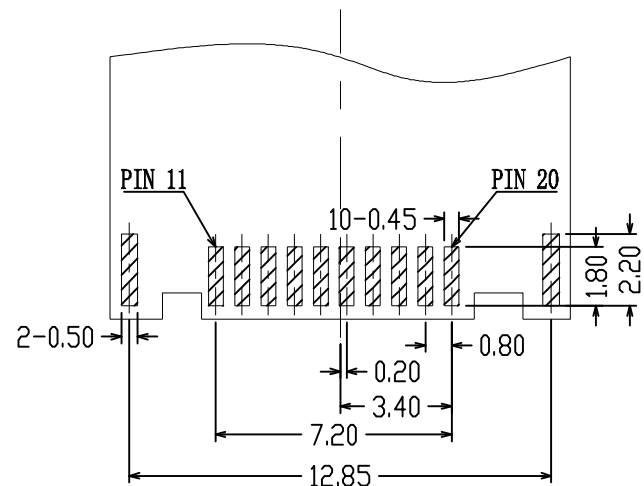
SECTION A-A
SCALE 1:1



APPROVALS		DATE	http://www.dongdudz.com		 ® 东都电子 DONGDU ELECTRONICS	
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:		
CHECKED:	***	****	30≥	±0.30		±2°
			10~30	±0.20		
			5~10	±0.15		
APPOVALS:	***	****	≤5	±0.10		

MODEL:	USB CONNECTOR	
PART NO:	USB 3.1-TYPE-B-A-J0.8	
UNIT :mm	SCALE:1:1	
REV:	A	PAGE:1/1

ROHS



PCB LAYOUT

NOTES:

1. IF emi shell solder lead is connected
To the adjacdat GND Pin viatrace,
IT NEED TO BE LSOLATED BY SOLDER RESISAT.
如果电磁干扰外壳焊线连接到邻接的接地引脚上,
需要用阻焊剂隔离

Pin Map to support one Type-C port

P11	P12	P13	P14	P15	P16	P17	P18	P19	P20
VBUS	TX2+	TX2-	GND	RX2+	RX2-	GND	D-	D+	CC2
SBU2	SBU1	CC1	VBUS	RX1-	RX1+	GND	TX1-	TX1+	VBUS
P10	P9	P8	P7	P6	P5	P4	P3	P2	P1

Pin Map to support two Standard-A ports

P11	P12	P13	P14	P15	P16	P17	P18	P19	P20
VBUS			GND			GND	D-	D+	
			VBUS	RX1-	RX1+	GND	TX1-	TX1+	VBUS
P10	P9	P8	P7	P6	P5	P4	P3	P2	P1

Material List:

4	CAP	1	LCP E130i+30%G/F	(UL94V-0) BLACK/WHITE
3	SHELL	1	SUS304-H T=0.15mm	镍底: 50u" min, 全雾锡: 80~200u"
2	CONTACTS	20	C5210-EH T=0.15mm	镍底: 50u" min, 焊接区镀雾锡: 80~200u" 接触区镀金: 详见备注
1	HOUSING	1	LCP E130i+30%G/F	(UL94V-0) BLACK/WHITE
No.	PART NAME	Q' TY	MATERIAL	REMARK

APPROVALS		DATE	http://www.dongdudz.com		
DRAW:	ZRD	2017-12-6	TOLERANCE:		ANGLE:
CHECKED:	***	****	30≥	±0.30	±2°
			10~30	±0.20	
			5~10	±0.15	
APPROVALS:	***	****	≤5	±0.10	

 东都电子		
DONGDU ELECTRONICS		
MODEL:	USB CONNECTOR	
PART NO:	USB 3.1-TYPE-E-A-J0.8	
UNIT :mm	SCALE:1:1	
REV:	A	PAGE:2/2